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102569484

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Junji YAMADA, Seiji SAIKI

9-29-03

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Name: MITSUBISHI DENKI KABUSHIKI KAISHA

Address: 2-3, Marunouchi 2-chome, Chiyoda-ku,
Tokyo 100-8310, Japan

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of Conveyance:

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Execution Date: August 28, 2003

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4. Application number(s) or patent number(s):

10671592

If this document is being filed together with a new application, the execution date of the application is: August 28, 2003

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

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6. Total applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

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PATENT
REEL: 014553 FRAME: 0213

Page 1 of 2

Seiji SAIKI of Fukuoka, Japan

_____, respectively

have invented certain new and useful improvements in: _____
SEMICONDUCTOR POWER MODULE

for which an application for Letters Patent was executed on August 28, 2003
(Application No. _____, filed _____), and

WHEREAS, MITSUBISHI DENKI KABUSHIKI KAISHA
(hereinafter referred to as "ASSIGNEE") having a place of business at: _____
2-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8310 Japan
is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

1/95

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of Oblon, Spivak, McClelland, Maier & Neustadt, P.C. of Fourth Floor, 1755 Jefferson Davis Highway, Arlington, Virginia 22202 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: <u>August 28, 2003</u>	<u>Junji Yamada</u> (Signature of Inventor) Junji YAMADA
Date: <u>August 28, 2003</u>	<u>Seiji Sasaki</u> (Signature of Inventor) Seiji SAIKI
Date: _____	_____ (Signature of Inventor)
Date: _____	_____ (Signature of Inventor)
Date: _____	_____ (Signature of Inventor)
Date: _____	_____ (Signature of Inventor)
Date: _____	_____ (Signature of Inventor)
Date: _____	_____ (Signature of Inventor)

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